



ISU ECpE Senior Design Group

MAY 14-03

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Design and implementation of a cryogenic electrical characterization system for organic electronic devices

Client: ISU Nanolab, Dr. Chaudhary and Dr. John Carr



Project Description

MOTIVATION, GOALS, AND OVERVIEW



ORGANIC ELECTRONIC DEVICES

Promising new technologies...

...but only if **efficiency** can be improved!

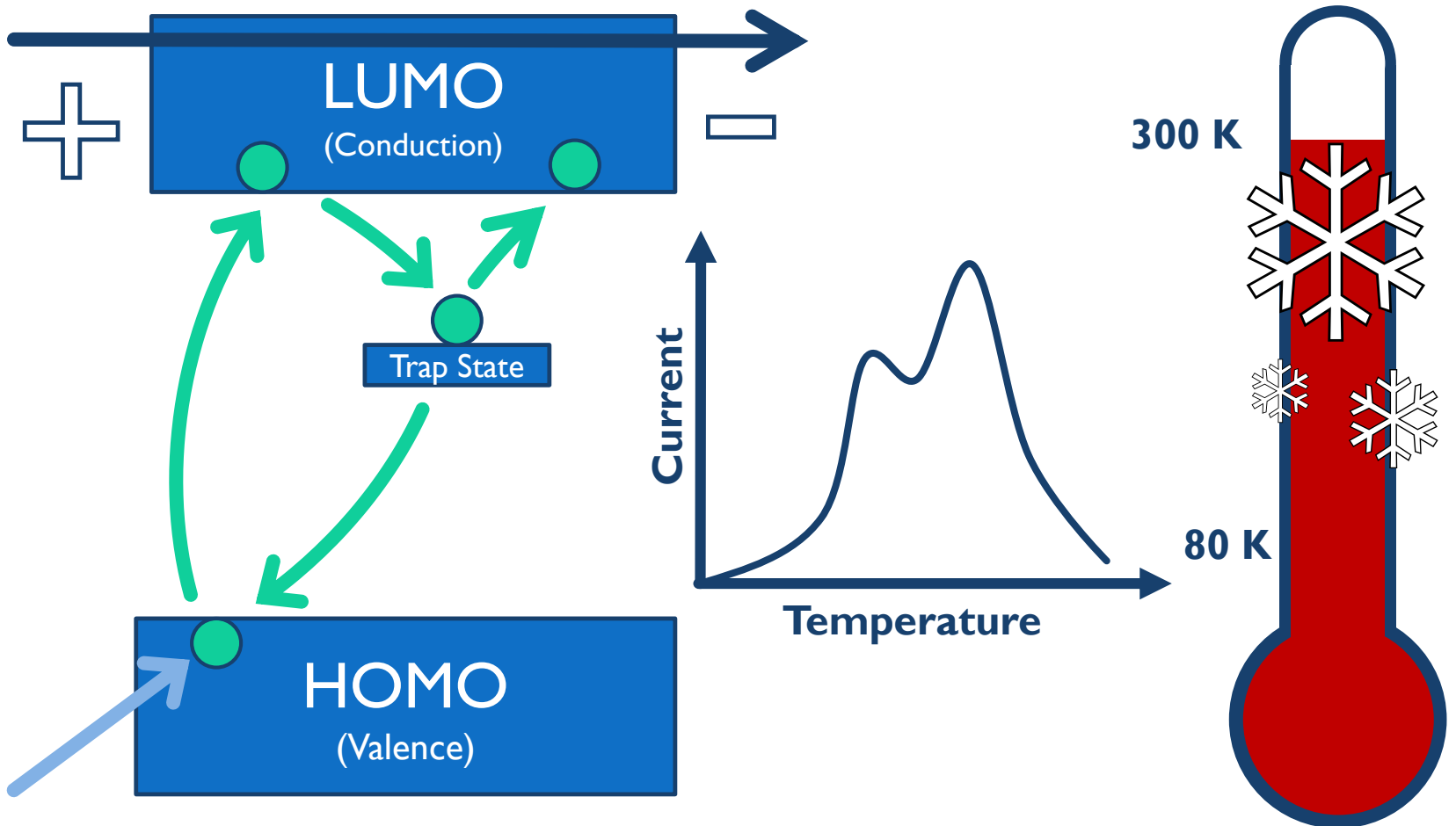
Electronic defects are one major obstacle.

The method of **Thermally Stimulated Currents (TSC)** can help us examine those defect states...

...but setups are expensive and complicated!

Our project is to design and build a simple TSC system for our client.

BRIEF OVERVIEW: THERMALLY STIMULATED CURRENT MEASUREMENTS



PROJECT GOALS

Where we started

- Liquid nitrogen cryostat and vacuum chamber
- No verification of cell temperature
- Current meter with 10 pA resolution
- Manually controlled instrumentation setup

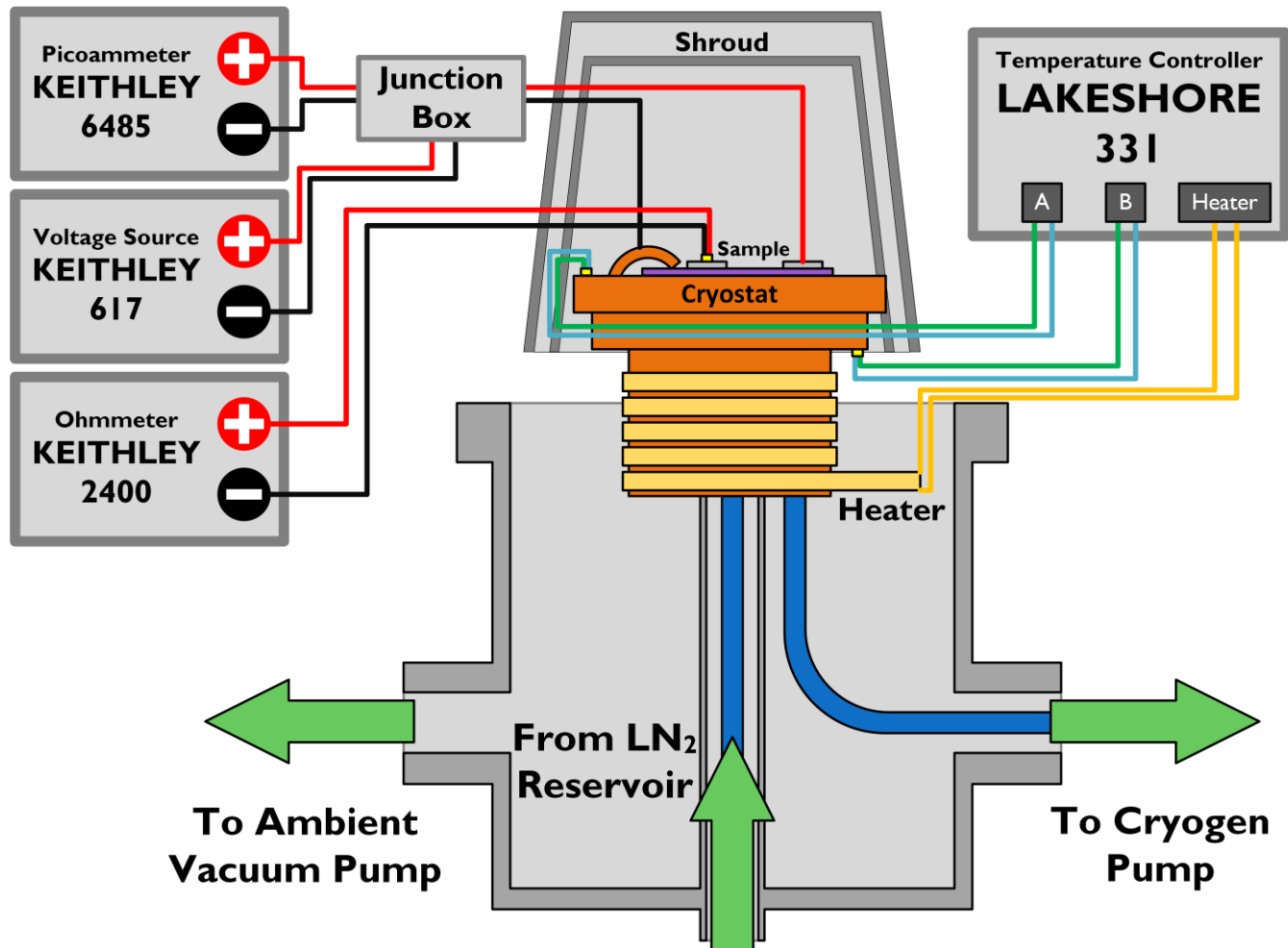
What was needed

- Must be able to bring sample to 80 K
- Need a method of real-time measurement
- Need 1000x better current resolution
- Experiment operation and data collection must be automated

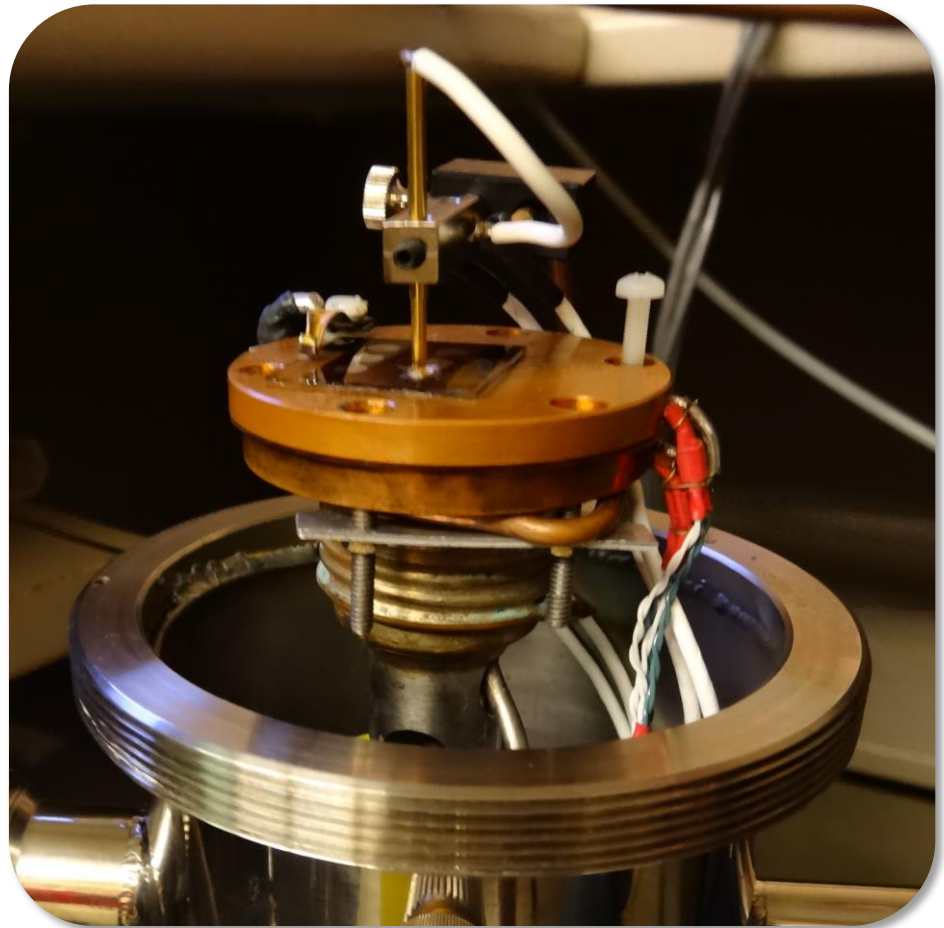
MARKET COMPARISON AND LITERATURE SURVEY

- No dedicated commercial systems for TSC exist!
- High quality cryostats cost \$30,000 or more
- Most research papers publish very few implementation details
- Spoke with researchers from Ames Lab
 - Significant experience with cryogenic systems
- Compared literature for different components
 - Temperature Sensors
 - Thermal interface materials
 - Insulation
 - Low current measurements

SYSTEM OVERVIEW



SYSTEM OVERVIEW (BEGINNING)





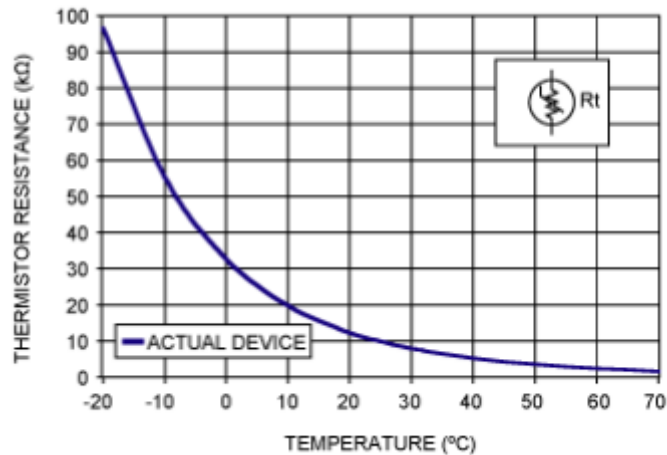
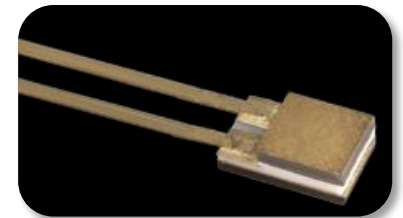
TECHNICAL CHALLENGES

AND THEIR SOLUTIONS

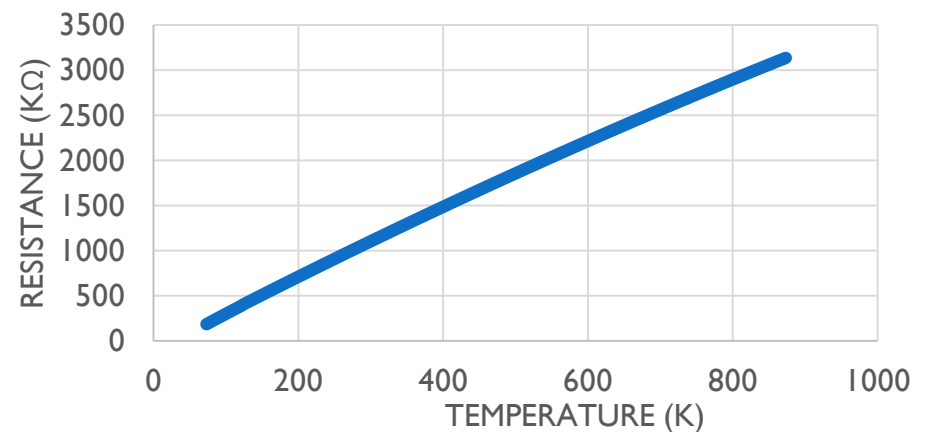


TEMPERATURE SENSORS

- Thermocouples
- Silicon Diodes
- Thermistors
 - NTC Semiconductor
 - PTC Metal



Platinum RTD

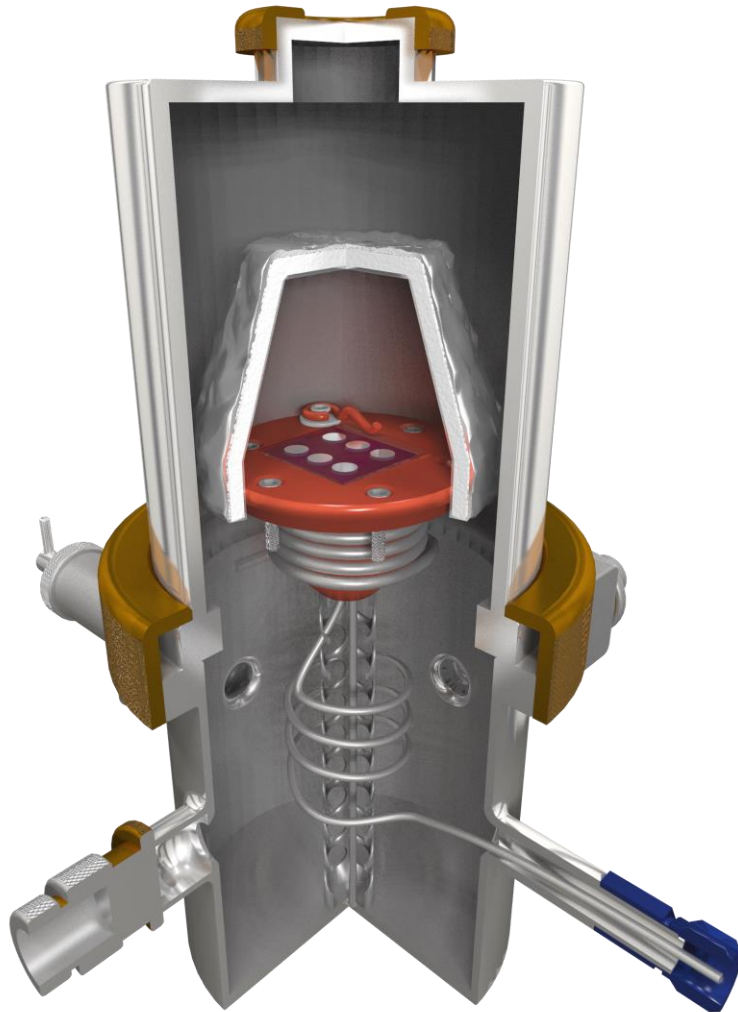


INSULATION



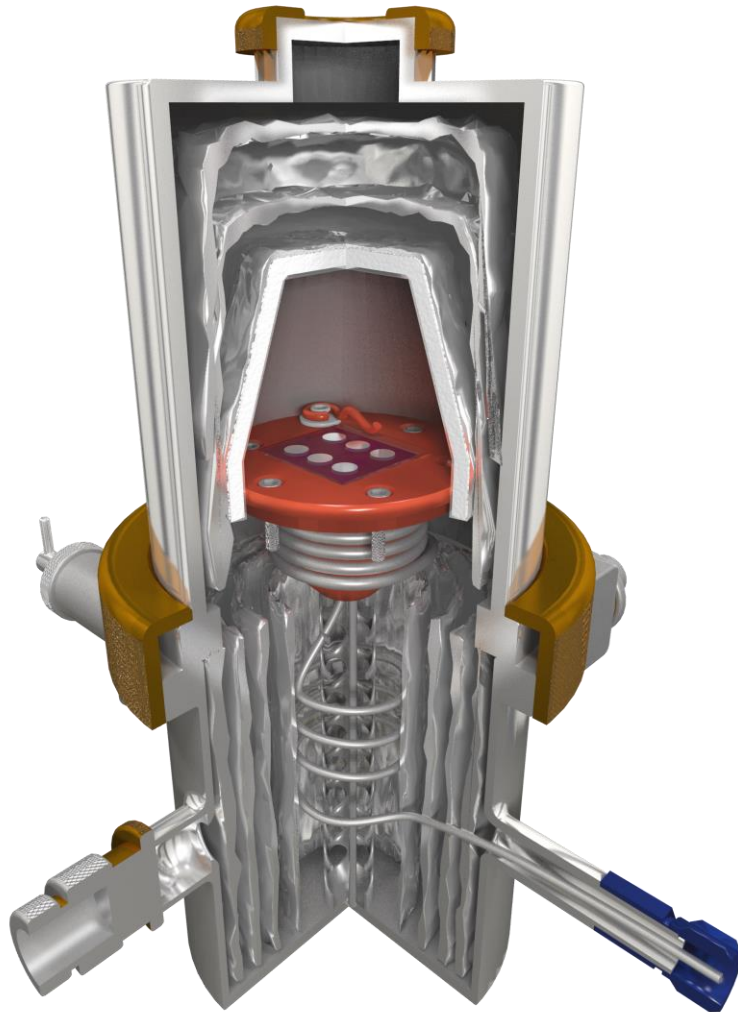
- Radiative heating is one of the largest problems
- Heater efficiency is low: poor temp. control
- Solution: mask with reflective layers

INSULATION



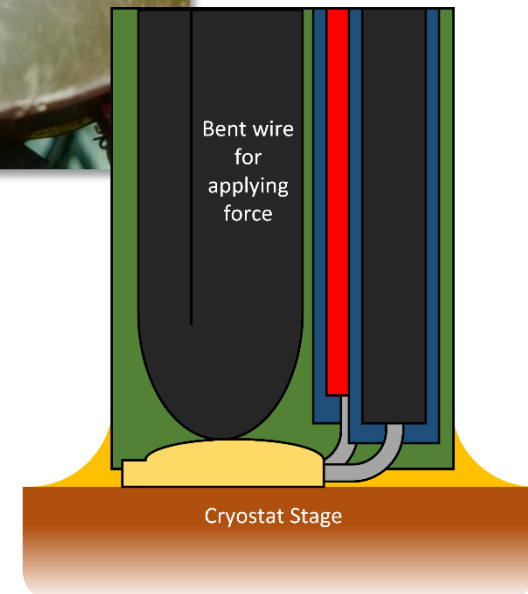
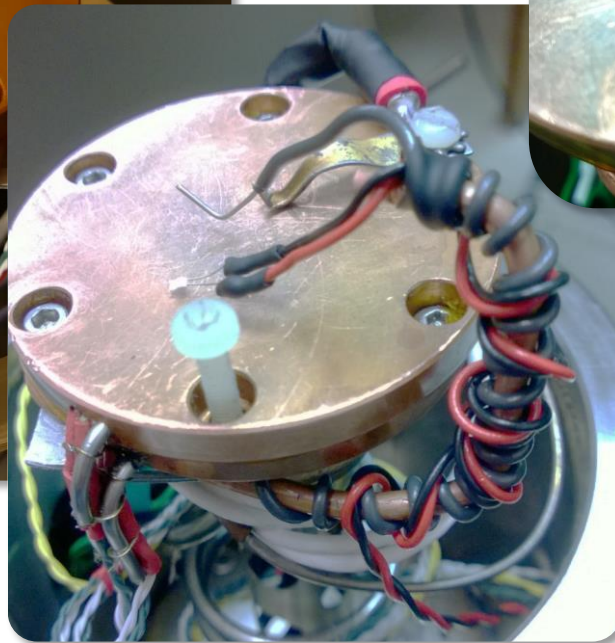
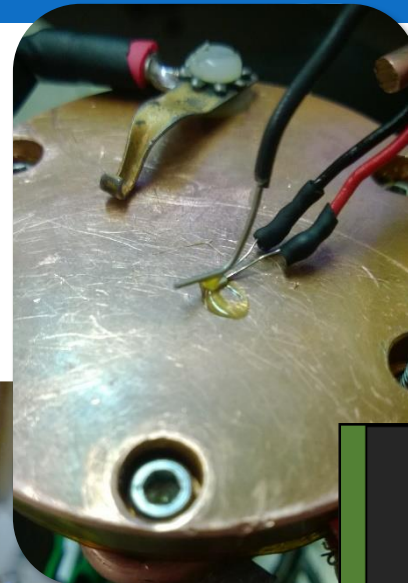
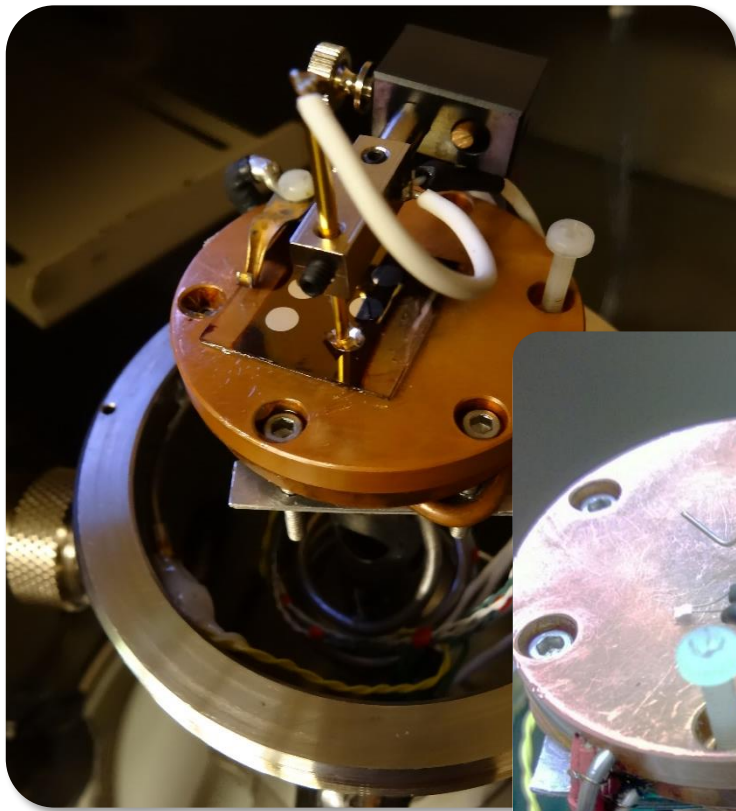
- “Cold shroud” reflects most heat
- Entire inner surface remains cold
- Prototype
 - Aluminum foil over Styrofoam, secured with zip-ties
- Final design
 - Layered aluminized Mylar sewn to Styrofoam with magnet wire

INSULATION



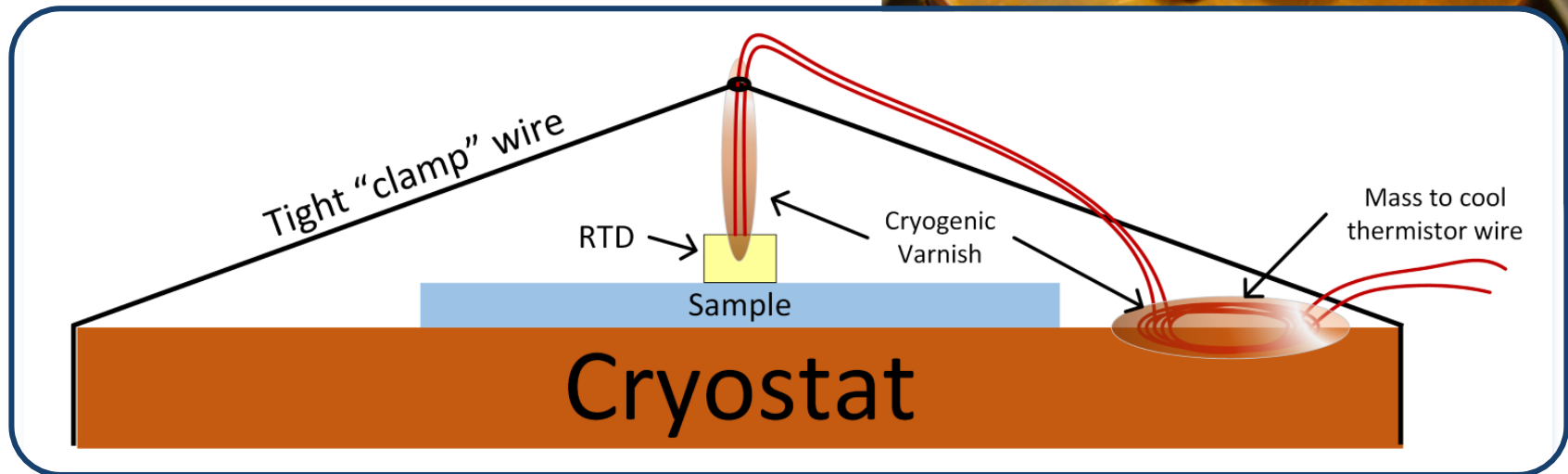
- Packing the remaining space with Mylar improves performance
- Top Half: Lowers minimum temperature
- Bottom Half: Increases heater efficiency, improving ramp rate control

PROBE EFFECTS

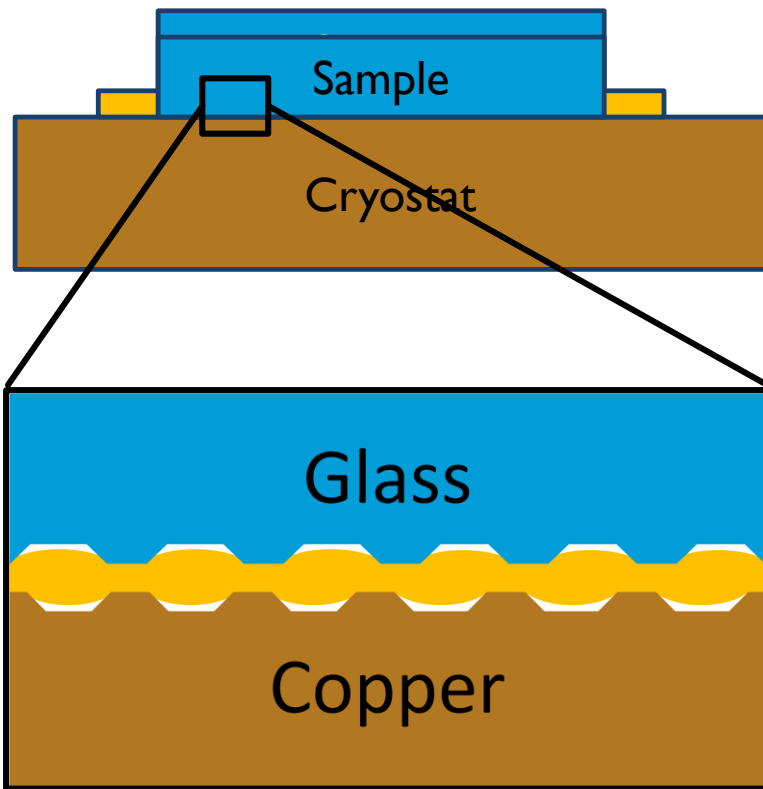


PROBE EFFECTS

- Thinnest wires possible, cooled on cryostat
- Wire tension used to hold tip down
 - Separated from sample surface

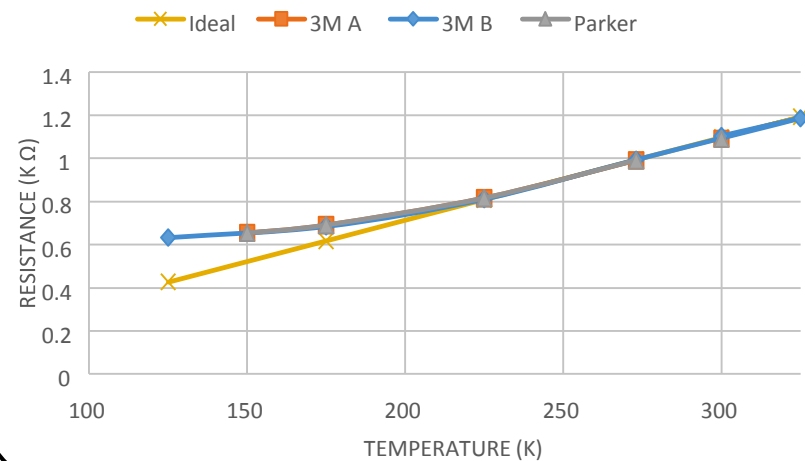


THERMAL INTERFACE MATERIALS

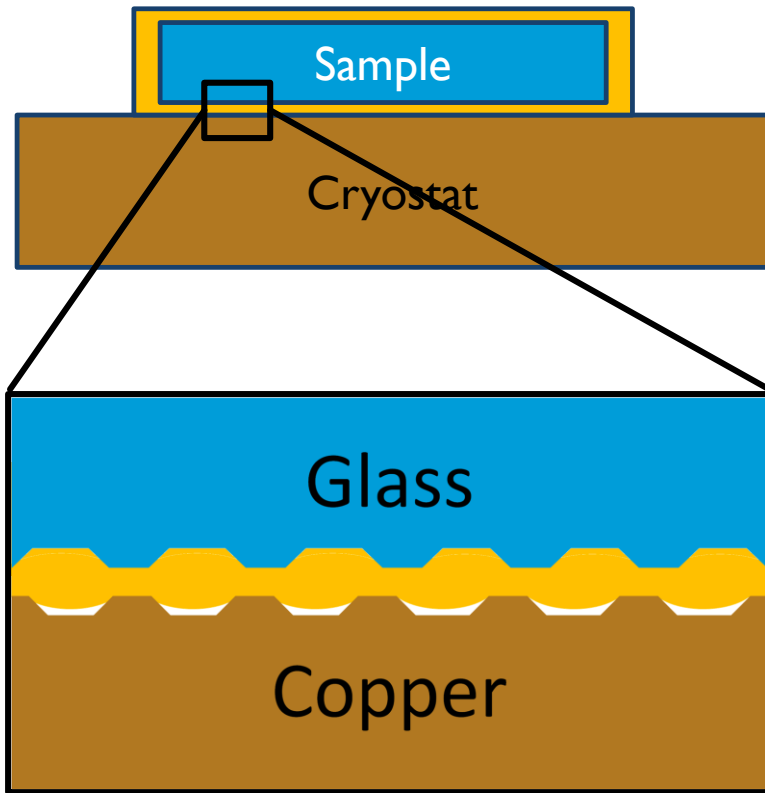


- Conformable Pads
 - Parker Chomerics
 - 3M

THERMAL PAD FREEZEOUT

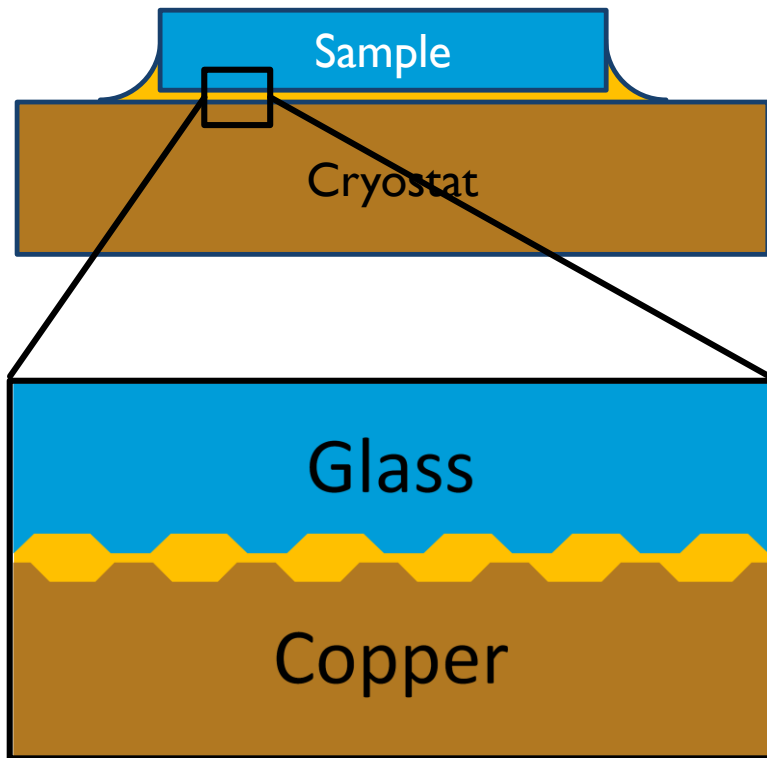


THERMAL INTERFACE MATERIALS



- Conformable Pads
 - Parker Chomerics
 - 3M
- Cryogenic Epoxy
 - Stycast 1266
 - Reacted with organic layer!

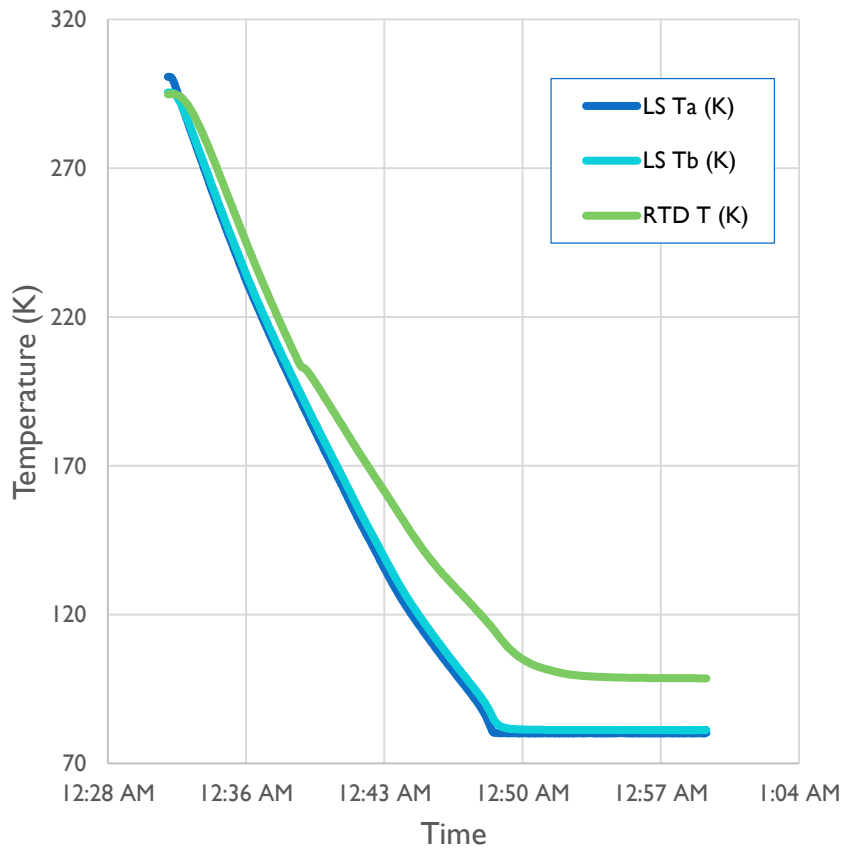
THERMAL INTERFACE MATERIALS



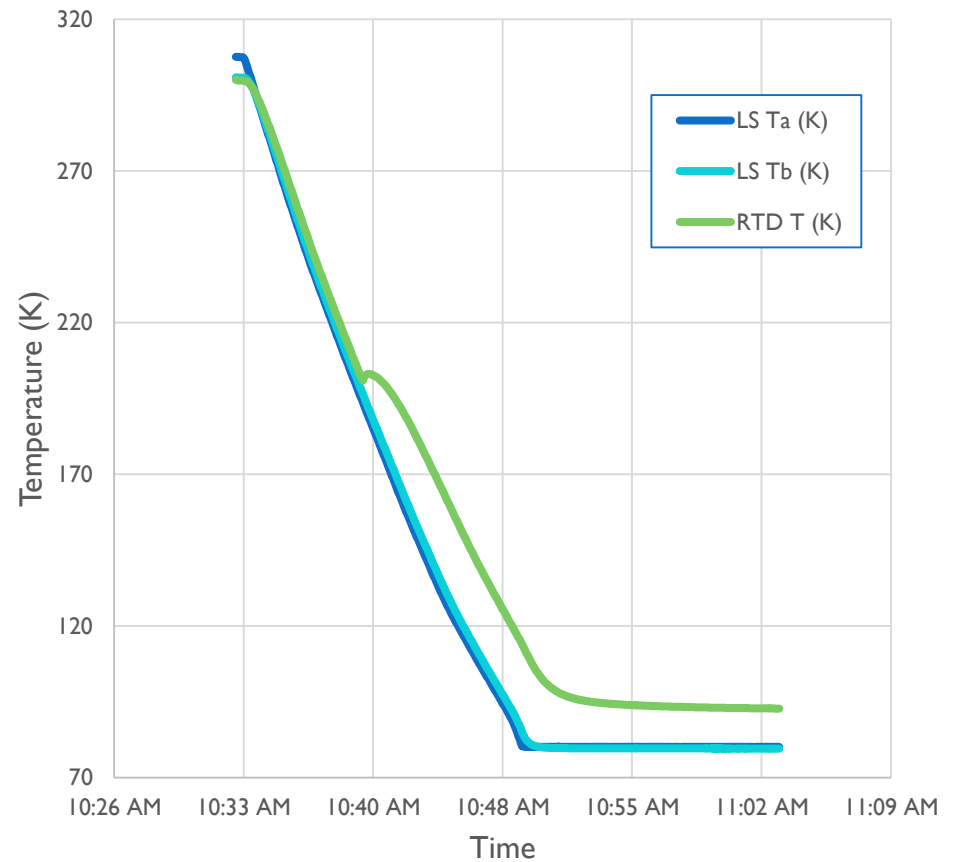
- Conformable Pads
 - Parker Chomerics
 - 3M
- Cryogenic Epoxy
 - Stycast 1266
- Cryogenic Vacuum Grease
 - Apiezon N Grease
- Cryogenic Varnish
 - Lakeshore VGE-703 I

THERMAL INTERFACE MATERIALS

Aluminum shroud and grease

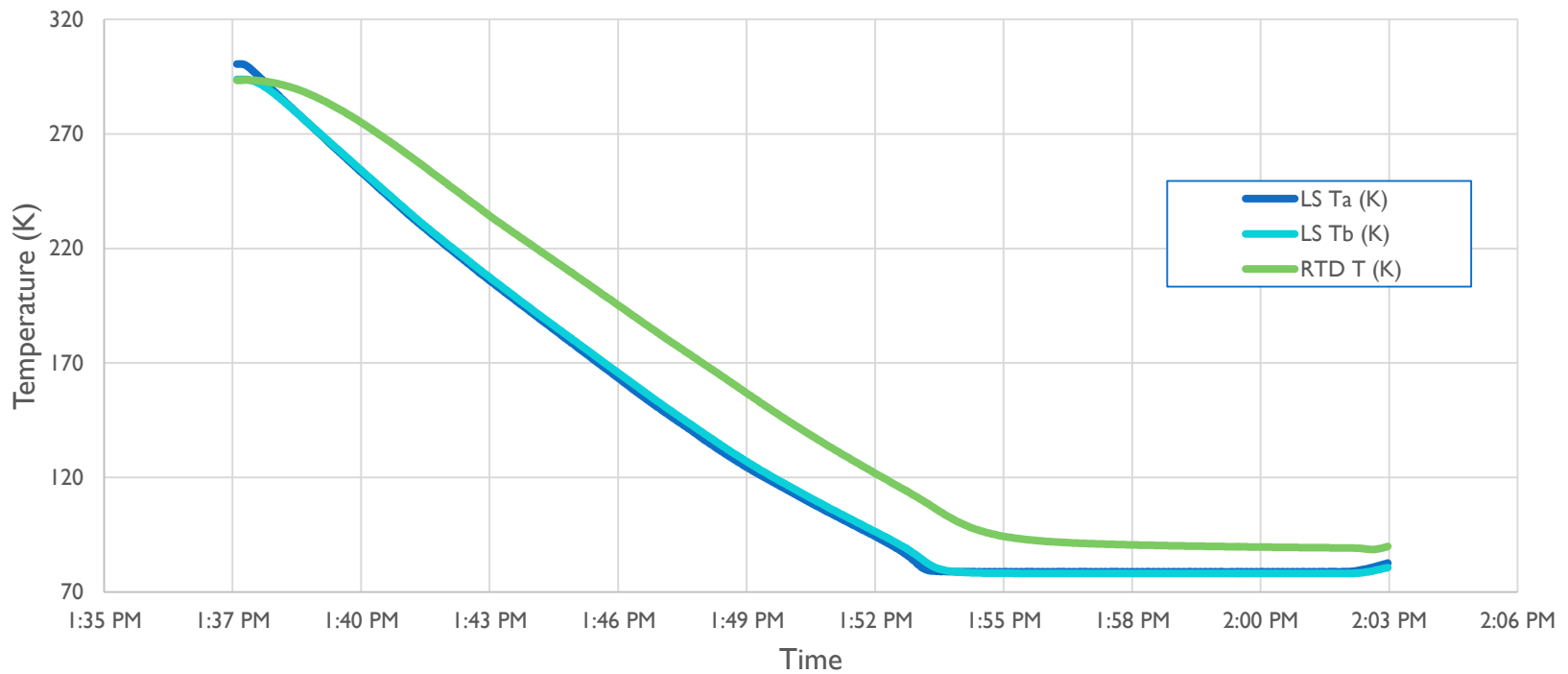


Mylar Shroud and Grease



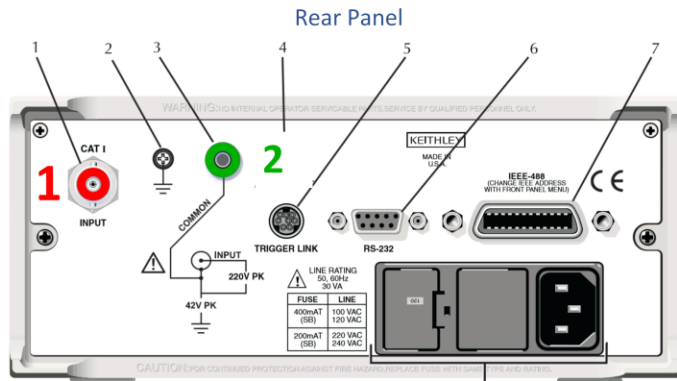
THERMAL INTERFACE MATERIALS

Mylar shroud, no grease

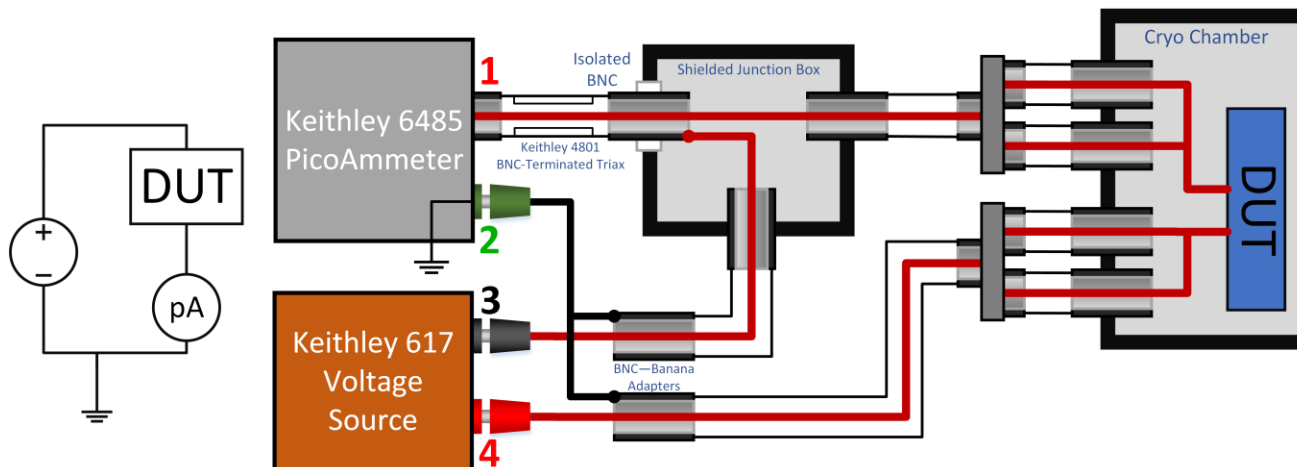
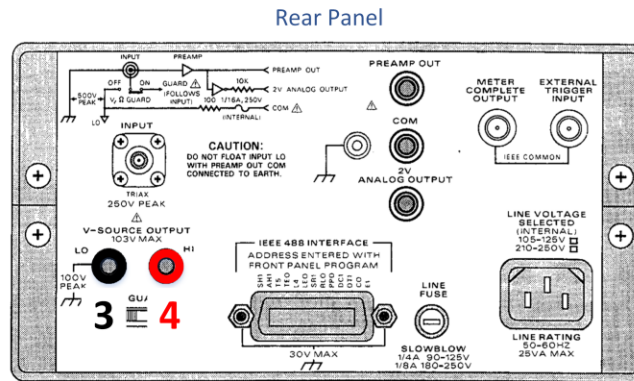


LOW CURRENT MEASUREMENTS

Keithley 6485 PicoAmmeter



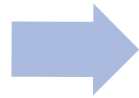
Keithley 617 Voltage Source



AUTOMATION SOFTWARE

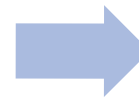
Flexible

- Allow for experiment customization
- Support multiple modes



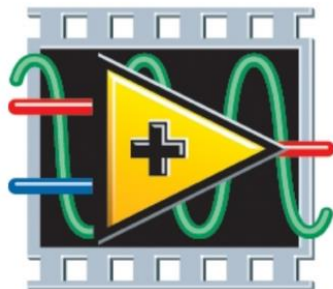
Robust

- Elegantly handle problems
- Keep user safe



Accessible

- Intuitive GUI
- Legible output



NATIONAL INSTRUMENTS

LabVIEW™

TSC Dashboard

Export to: Profile:

User: Cell Type: File Description:

Address	Identifier
GPIOB::12::INSTR	Lakeshore 331
GPIOB::14::INSTR	Keithley 6485
GPIOB::24::INSTR	Keithley 2400
GPIOB::27::INSTR	Keithley 617

Charge:

Charge Voltage:

Meas. Voltage:

Charge Time:

Temp Profile:

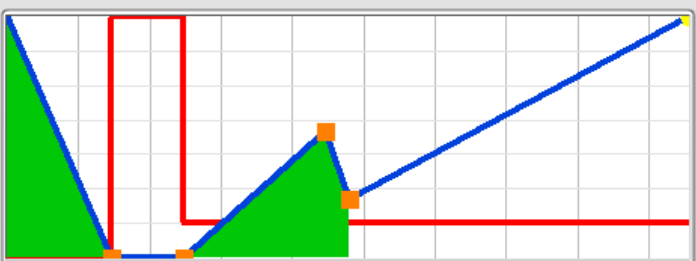
Ramp Rate:

Soak Time:

Points:

Setpoints:

1	80 K
2	160 K
3	110 K
4	300 K



Measuring

Temp Setpoint:

Time Started:

Voltage:

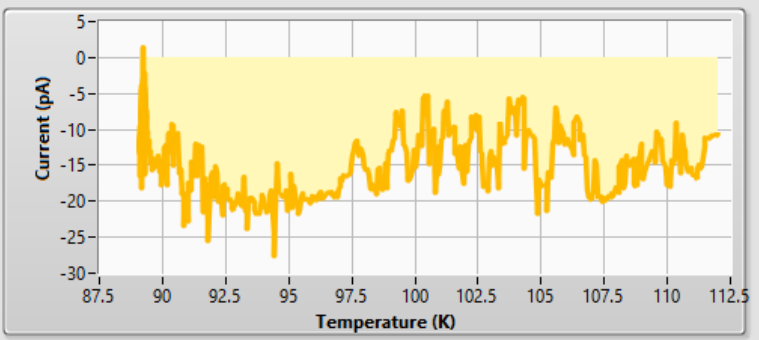
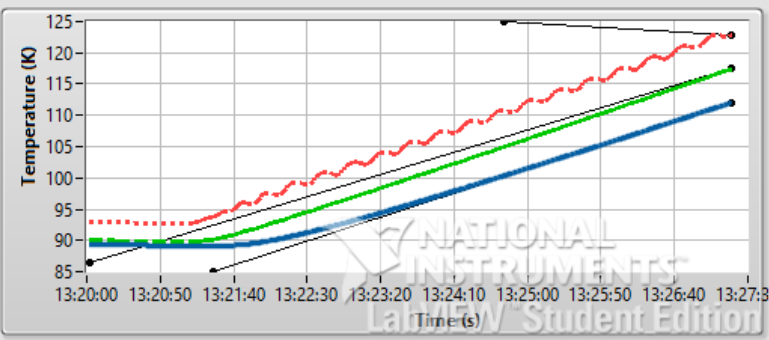
Est. Time Left:

12598	13:27:18.593	300.00	111.98	4.60	122.74	-2.15	117.34	4.25
12599	13:27:18.546	300.00	111.99	4.60	122.77	-2.15	117.35	4.25
12600	13:27:18.692	300.00	112.00	4.62	122.79	-0.82	117.36	4.27
12601	13:27:18.963	300.00	112.02	4.62	122.83	-0.82	117.38	4.27
12602	13:27:19.110	300.00	112.03	4.62	122.85	-0.82	117.39	4.27
12603	13:27:19.255	300.00	112.04	4.62	122.88	-0.82	117.41	4.27

Ctrl A: Ctrl B: Cell:

A Rate: B Rate: Cell Rate:

Current:



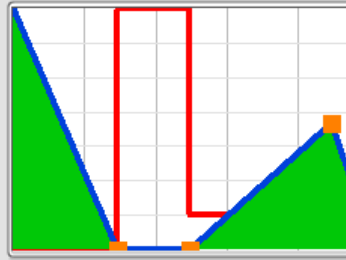
Export to: C:\Users\Joshua\Dropbox\Senior Design Group May1403\Automation Software\Results

Profile: Basic Fractional

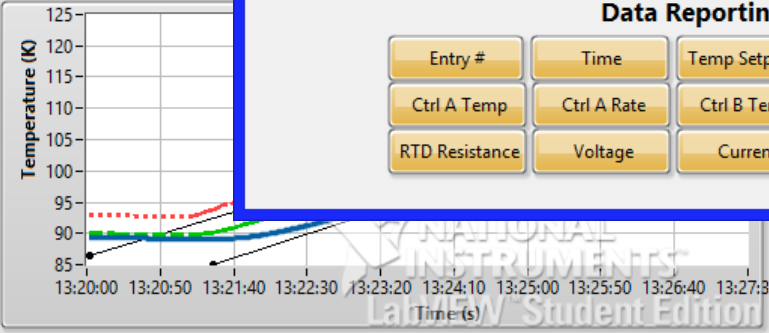
User: Josh

Address	Identifier
GPIOB::12::INSTR	Lakeshore 331
GPIOB::14::INSTR	Keithley 6485
GPIOB::24::INSTR	Keithley 2400
GPIOB::27::INSTR	Keithley 617

Search for Devices GPIB STA



Ctrl A: 122.88 K
A Rate: -0.82 K/min



Advanced Settings

Connected Devices

LSCI,MODEL331S,331823,032301

KEITHLEY INSTRUMENTS INC.,MODEL 6485,4042439,C01

KEITHLEY INSTRUMENTS INC.,MODEL 2400,1259388,C30

NDCV+0.00000E+02

Search for Devices **GPIB STATUS**

LakeShore Settings

Ctrl A Input: 4,1 Ctrl B Input: 07

Ctrl A Curve: 4,1 Ctrl B Curve: 07

Use as A Curve: Ch. 7 Use as B Curve: Ch. 7

Heater Range: High Update LakeShore

Limit Settings

Min Temp: 80 K Max Rate: 10 K/min

Max Temp: 350 K Max Voltage: 20 V

RTD R-T Coefficients
($T = A + B \cdot R + C \cdot R^2 + D \cdot R^3$)

A: 31.483 C: 2.82966E-5

B: 0.220024 D: -6.6196E-9

Rate Control Settings

P: 0.01 I: 0 D: 0

Data Reporting Options

Entry #	Time	Temp Setpoint	Cell Temp	Cell Rate
Ctrl A Temp	Ctrl A Rate	Ctrl B Temp	Ctrl B Rate	Heater %
RTD Resistance	Voltage	Current	Sampling:	

Accept Changes

Reset to Defaults

Discard Changes

Start

Next

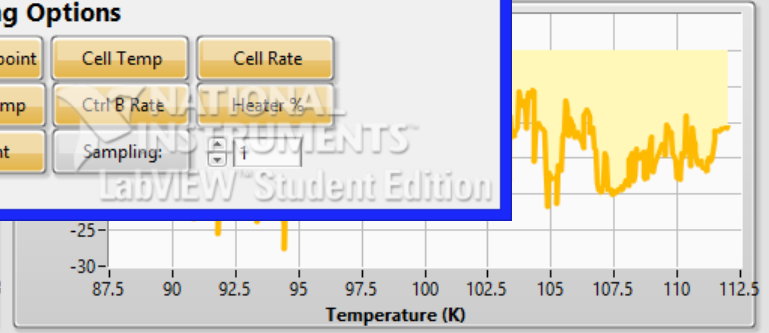
Stop

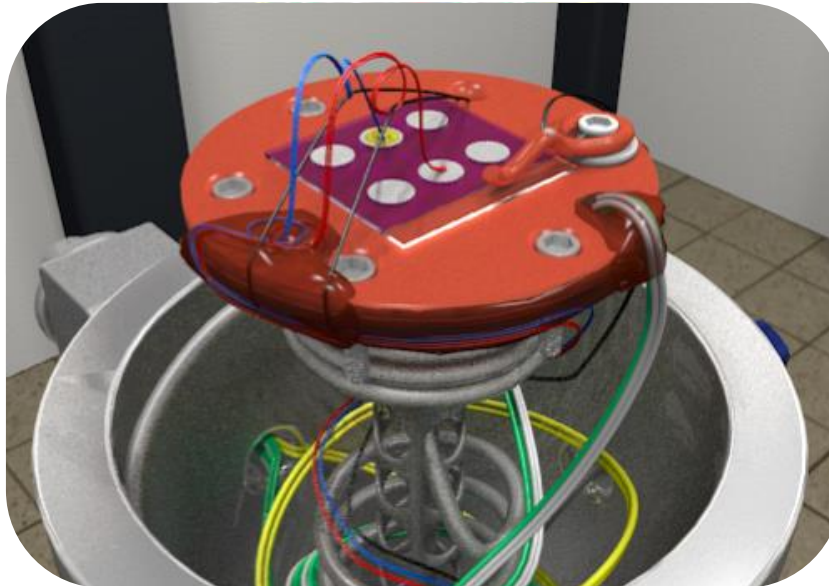
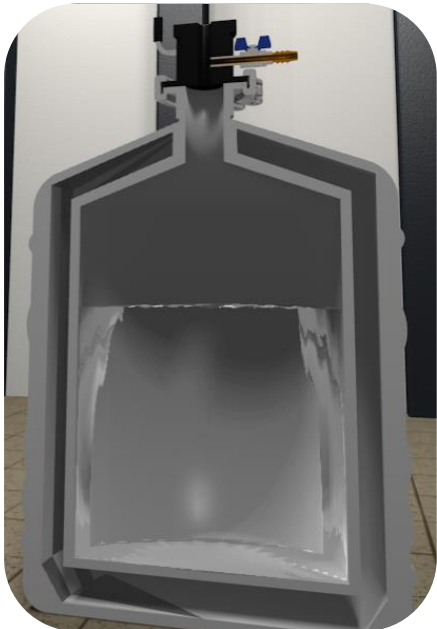
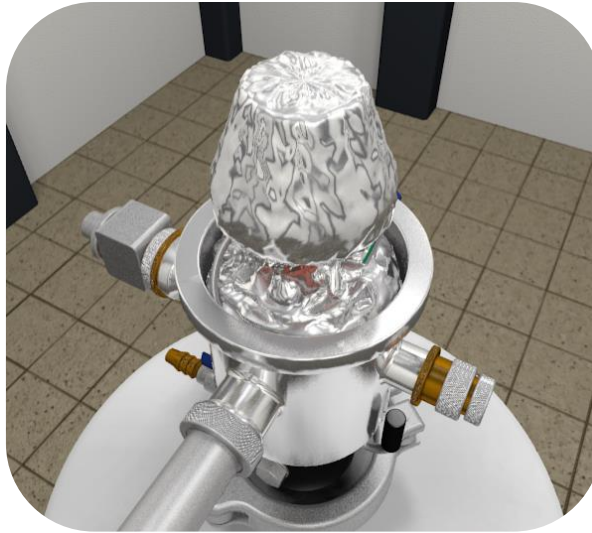
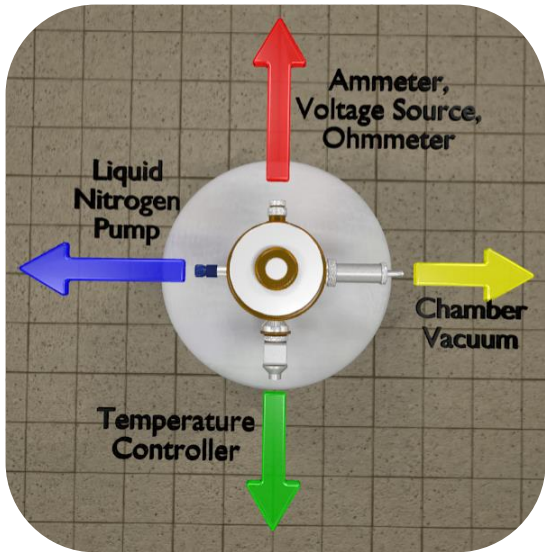
60	122.74	-2.15	117.34	4.2
60	122.77	-2.15	117.35	4.2
62	122.79	-0.82	117.36	4.2
62	122.83	-0.82	117.38	4.2
62	122.85	-0.82	117.39	4.2
62	122.88	-0.82	117.41	4.2

Comment

Clear Graphs

Show Tangents







QUESTIONS?





APPENDICES



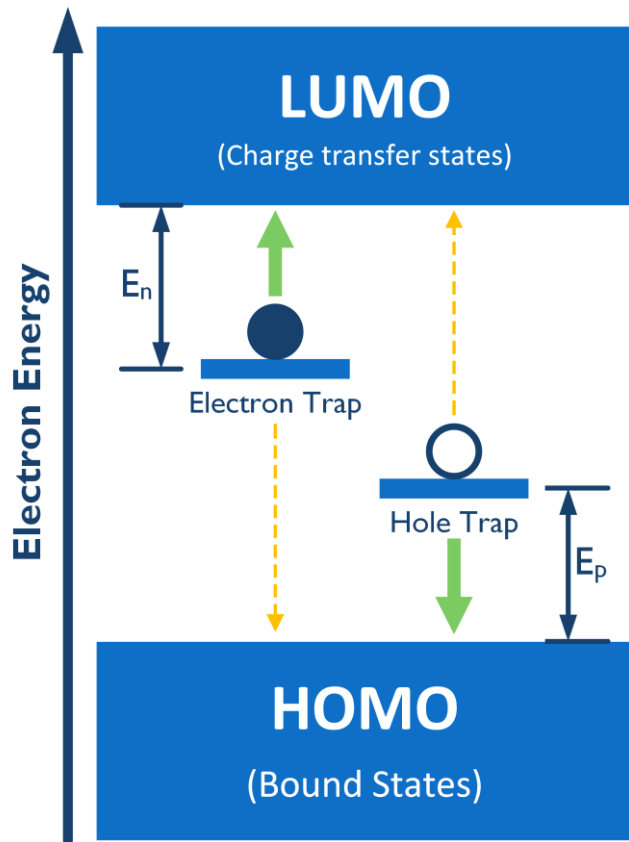
RESOURCE REQUIREMENTS

Resource	How will we get it?	Cost
Cryostat	Provided by client	---- N/A ----
Dewar flask	Provided by client	---- N/A ----
Liquid nitrogen	Provided by client	---- N/A ----
Aluminum Foil	Provided by client	---- N/A ----
Source measurement unit	Provided by client	---- N/A ----
Ohmmeter	Provided by client	---- N/A ----
Temperature controller	Provided by client	---- N/A ----
Computer with LabVIEW installed	Provided by client	---- N/A ----
GPIB interface cables	Provided by client	---- N/A ----
Thermally conductive grease	Provided by client	---- N/A ----
Wire shielding (conductive braid)	Provided by client	---- N/A ----
Cryogenic Varnish	Provided by client	---- N/A ----
New Platinum RTDs	PPG101A6, US Sensor (Digikey)	\$ 58.44
Thermally conductive epoxy	Stycast 1266 Cryogenic Epoxy (CMR Direct)	\$ 197.75
Thermal interface pad	5519 or 5591S Pads from 3M	\$ 61.06
Connectors and wires	Digikey	\$ 109.62
Junction Box Materials	Digikey	\$ 50.48
Mylar Insulation	Edmund Scientifics	\$ 31.90
Keithley 6485 Picoammeter	Keithley/Tektronix	\$ 1,660.00
TOTAL:		\$ 2,169.25

PROJECT SCHEDULE

ID	Task Name	2013				2014			
		Sep	Oct	Nov	Dec	Jan	Feb	Mar	Apr
1	Research	■							
2	Part Acquisition		■						
3	Testing new parts		■						
4	Preliminary Runs			■					
5	Software Design				■				
6	System Assembly					■			
7	Full system tests						■		
8	Troubleshooting							■	

DE-TRAPPING KINETICS



De-trapping Rate:

$$R(T) = \nu_0 \cdot \exp\left(-\frac{\Delta E}{k_B T}\right)$$

ν_0 = attempt-to-escape frequency

Trap Characterization

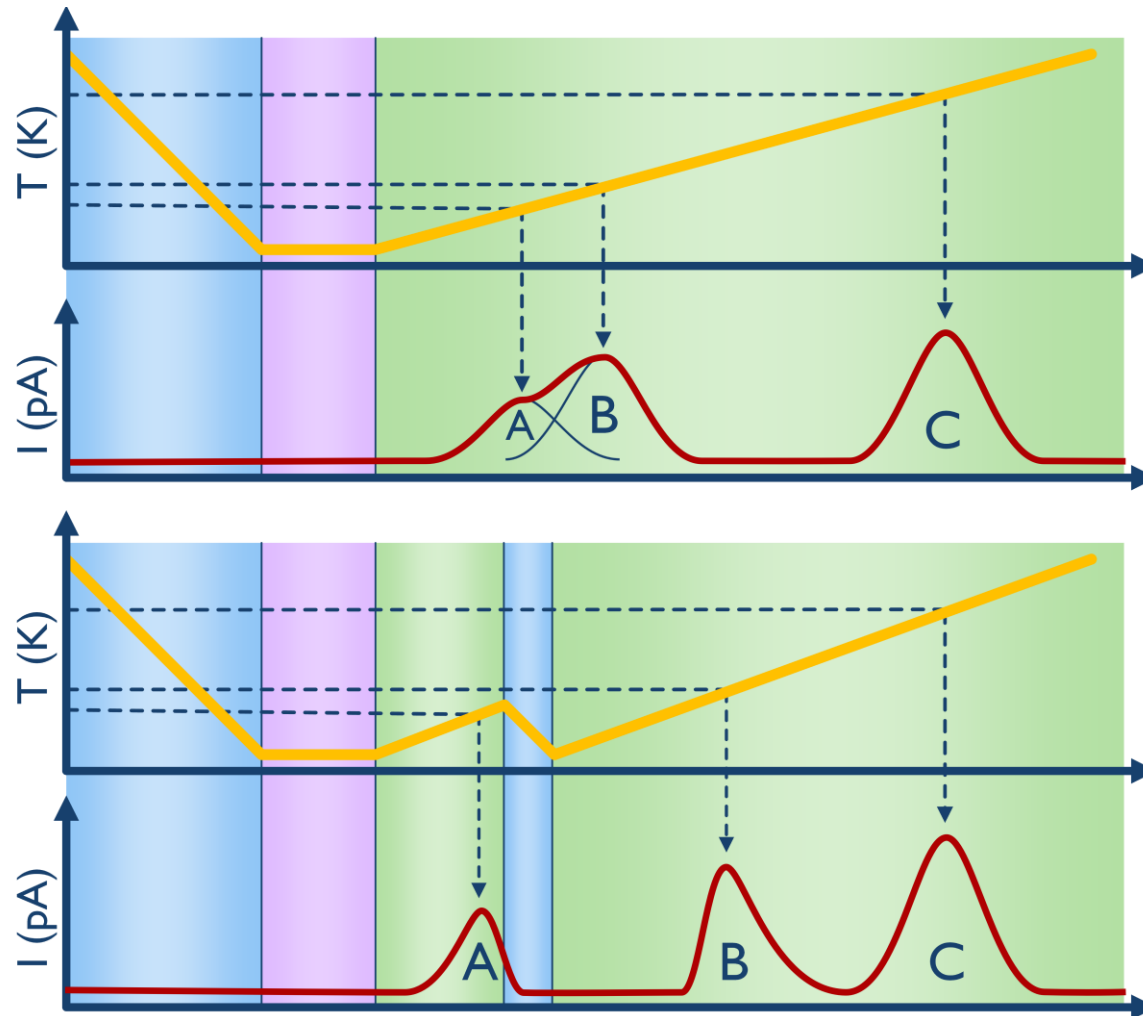
$$E_i = k_B T_m \frac{\ln(N \sigma \nu k_B T_m^2)}{\beta E_i}$$

N = effective density of states

ν = carrier thermal velocity

β = thermal scan heating rate

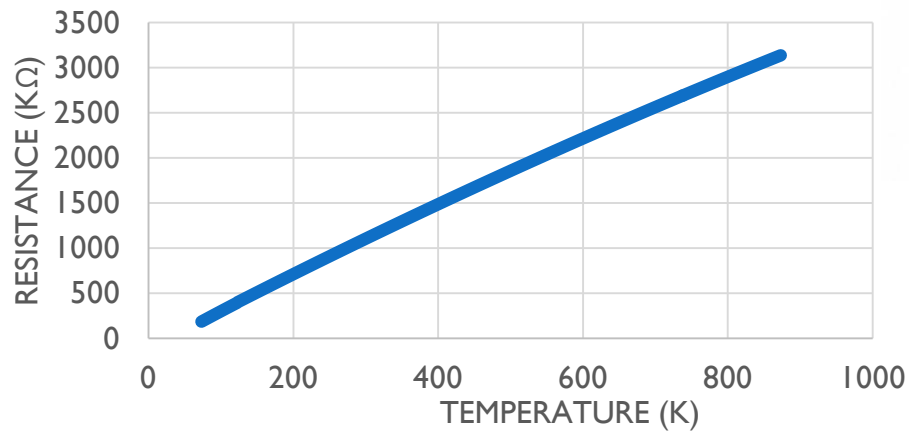
TSC AND FRACTIONAL TSC



US SENSOR PPG102A6

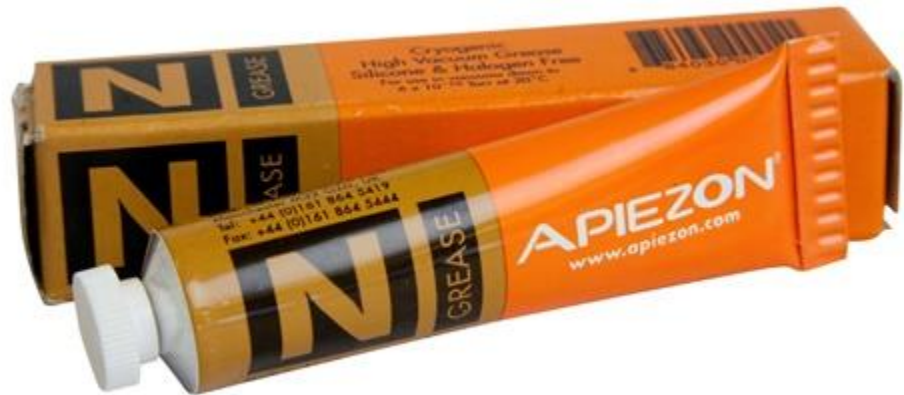
- $1000\ \Omega \pm 0.06\%$
- Range: -200°C to $+600^{\circ}\text{C}$ (73.15 K to 873.15 K)
- Platinum-Nickel Leads
- Linear TCR: 3,850 ppm/K
- \$22.00 each

R-T Diagram



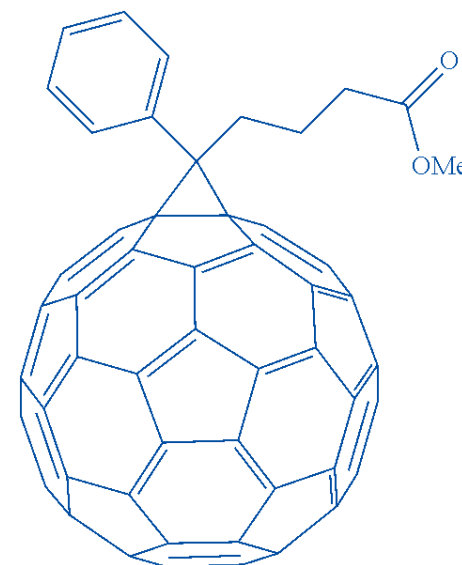
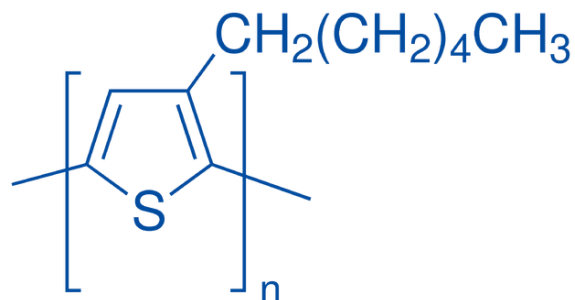
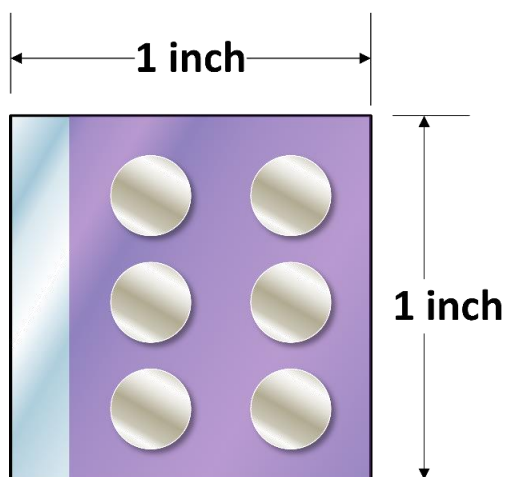
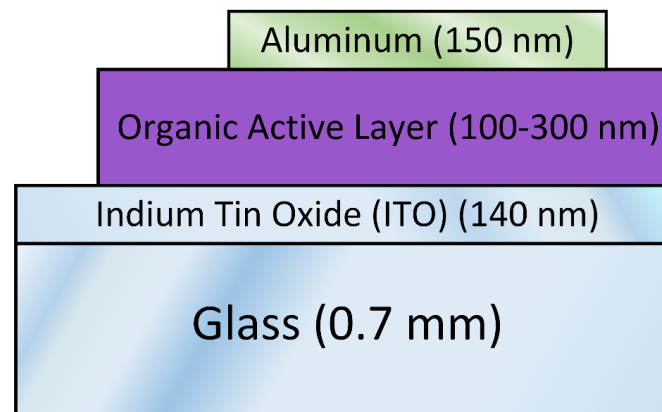
APIEZON N GREASE

- Temperature Range: 0.15 K to 300 K
- Thermal Conductivity (80 K) = $0.1 \text{ W m}^{-1} \text{ K}^{-1}$
- Vapor Pressure (273 K) = $2.67 \times 10^{-7} \text{ torr}$
- Volume Resistivity $2 \times 10^{16} \text{ } \Omega \text{ m}$

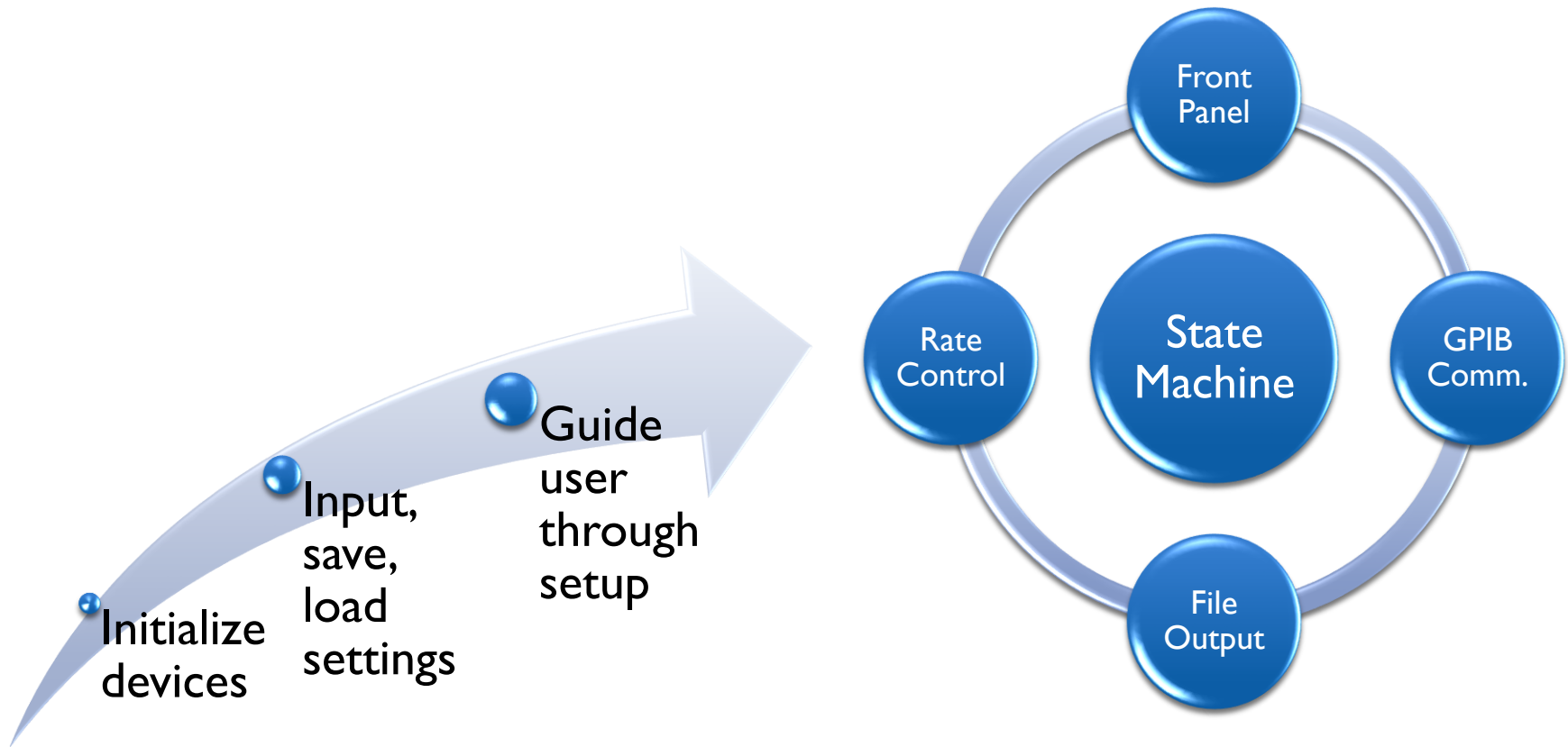


SOLAR CELL SAMPLES

- Bulk heterojunction
 - Poly-3-hexylthiophene
 - Phenyl-C61-butyrac acid methyl ester
- Manufactured onsite using glass slides pre-deposited with ITO



SOFTWARE ARCHITECTURE



LAKESHORE TEMPERATURE CONTROLLER

- 3-mode variable power heater, 50 W
- Accurate down to 1.2 K
- Thermal EMF compensation for resistive sensors



KEITHLEY 6485 PICOAMMETER

- 5½ digit display
- Resolution: 10 fA
- 1000 reads per second
- Accuracy: $\pm 0.4\%$
- Coaxial hookups, triax adapters for low currents
- \$1,660 (with educational discount)



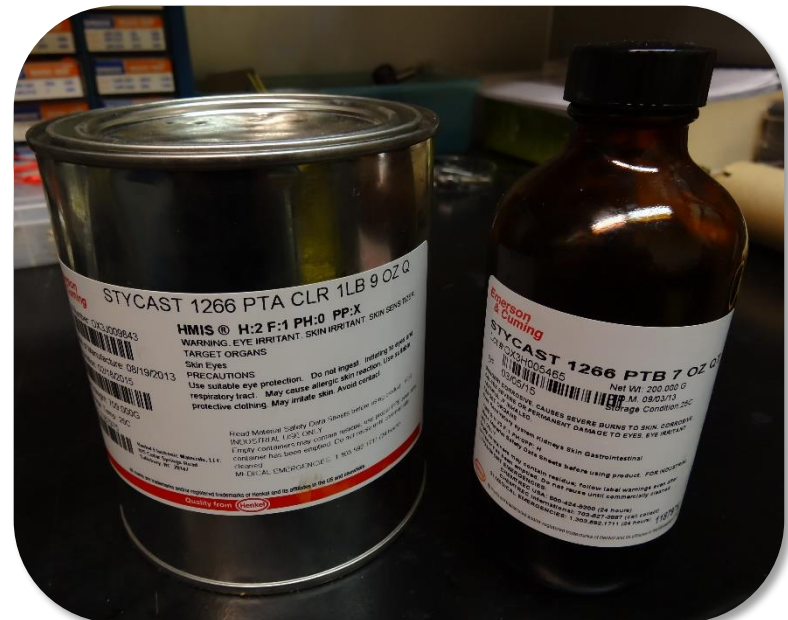
VGE-7031 CRYOGENIC VARNISH

- Clear modified phenolic
- Easy to apply and remove
- Rigid when dry
- Dissolves in ethyl alcohol
- Vacuum compatible to 10^{-9} Torr



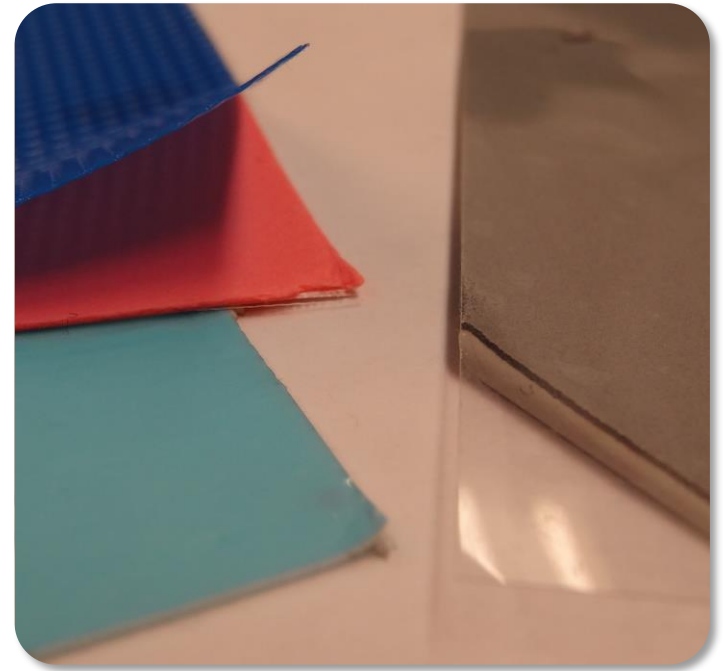
STYCAST 1266 CRYOGENIC EPOXY

- 2-part formula, 100 : 28 mix ratio by weight
- Low viscosity, lowered still by applied heat
- 30 minute working life, 8-16 hr. cure at 300 K
- Optically clear, electrically insulating



CONFORMAL THERMAL PADS

- 3M:
 - 5519S, 5591S
- Parker Chomerics:
 - Therm-A-Gap G579
- All three highly conformable, slightly tacky, electrically insulating
- Thermal conductivity (300K) 1-3 $\text{Wm}^{-1}\text{K}^{-1}$





OUR WEBSITE

<http://seniord.ece.iastate.edu/may1403/index.html>

